



Automotive-grade N-channel 60 V, 4.4 mΩ typ., 80 A STripFET™ F6 Power MOSFET in a DPAK package

Datasheet - production data

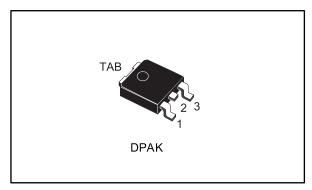
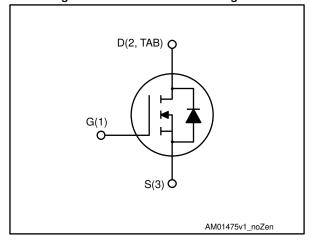


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STD80N6F6	60 V	5 mΩ	80 A



- AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using the STripFET $^{\text{TM}}$ F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{\text{DS(on)}}$ in all packages.

Table 1: Device summary

Order code	Marking	Marking Package Packa	
STD80N6F6	80N6F6	DPAK	Tape and reel

STD80N6F6 Contents

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STD80N6F6 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V_{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	80	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	80	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	320	Α
Ртот	Total dissipation at T _C = 25 °C	120	W
T _{stg}	Storage temperature range	55 to 175	۰,0
Tj	Operating junction temperature range	- 55 to 175	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.25	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

Notes:

⁽¹⁾Current limited by package.

 $[\]ensuremath{^{(2)}}$ Pulse width limited by safe operating area.

 $^{^{(1)}}$ When mounted on a 1-inch² FR-4 board, 2oz Cu.

Electrical characteristics STD80N6F6

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified).

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			٧
	Zoro goto voltago drain	$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V},$ $T_j = 125 ^{\circ}\text{C} ^{(1)}$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	3		4.5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 40 A		4.4	5	mΩ

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	8325	1	pF
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz},$	-	500	1	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	400	ı	pF
Qg	Total gate charge	$V_{DD} = 30 \text{ V}, I_{D} = 80 \text{ A}, V_{GS} = 0$	-	147	1	nC
Q_{gs}	Gate-source charge	to 10 V (see Figure 14: "Test circuit for	-	44	1	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	46	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 40 \text{ A},$	-	40		ns
tr	Rise time	R _G = 4.7 Ω , V _{GS} = 10 V (see Figure 13: "Test circuit for	1	71	1	ns
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	132	-	ns
tf	Fall time	and Figure 18: "Switching time waveform")	ı	40	ı	ns

 $^{^{(1)}\}mbox{Defined}$ by design, not subject to production test.

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		80	Α
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		320	Α
V _{SD} ⁽³⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 80 A	-		1.3	V
trr	Reverse recovery time	$I_{SD} = 80 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s},$	1	46		ns
Qrr	Reverse recovery charge	$V_{DD} = 48 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 15: "Test circuit for	-	65		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	2.8		Α

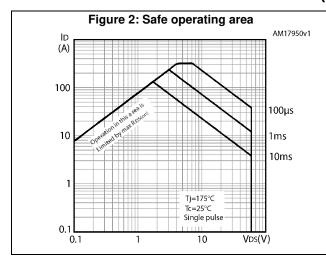
Notes:

⁽¹⁾ Current limited by package.

 $[\]ensuremath{^{(2)}}$ Pulse width limited by safe operating area.

 $^{^{(3)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)



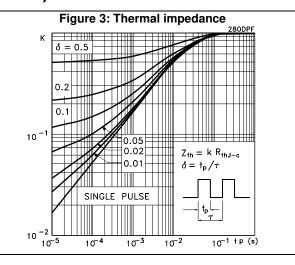
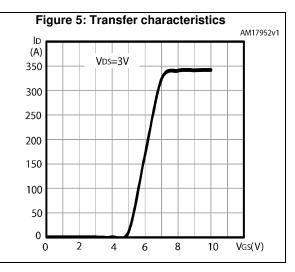
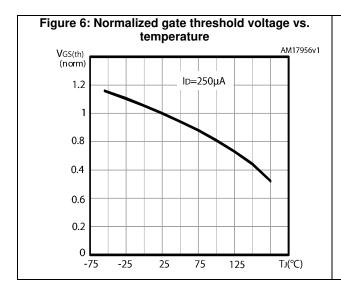


Figure 4: Output characteristics AM17951v1 ID(A) VGS=8, 9, 10V 350 300 250 200 150 100 50 <u>5V</u> VDS(V) 2 6 8 0





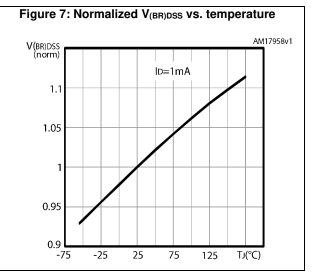


Figure 8: Static drain-source on-resistance

RDS(on) (mΩ) VGS=10V

10.0

8.0

4.0

2.0

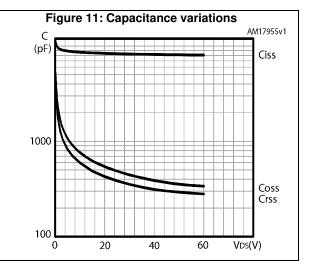
0.10 20 30 40 50 60 70 ID(A)

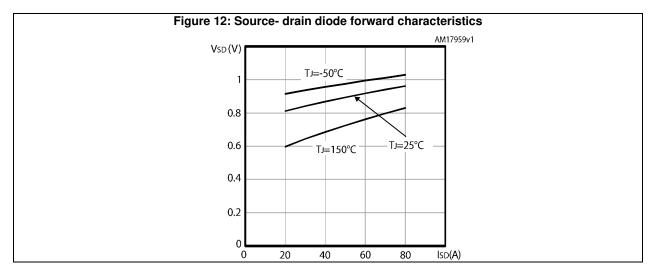
RDS(on) (norm) | ID=40A | ID=4

Figure 10: Gate charge vs. gate-source voltage

VGS
(V)
12
VDD=30V
ID=80A

4
2
0
0
50
100
150
Qg(nC)





Test circuits STD80N6F6

3 Test circuits

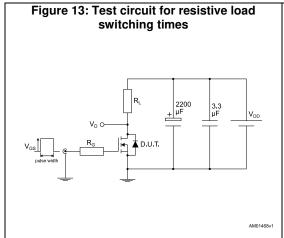
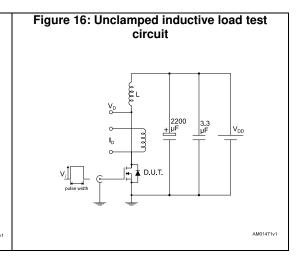


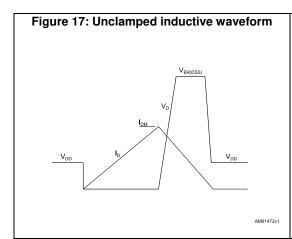
Figure 14: Test circuit for gate charge behavior

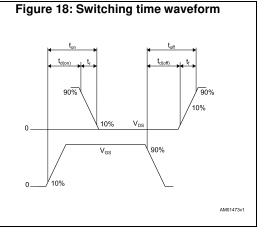
12 V 47 kΩ 100 nF D.U.T.

2200 PF 47 kΩ OVG

AM01469v1







4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 DPAK (TO-252) type A2 package information

Figure 19: DPAK (TO-252) type A2 package outline

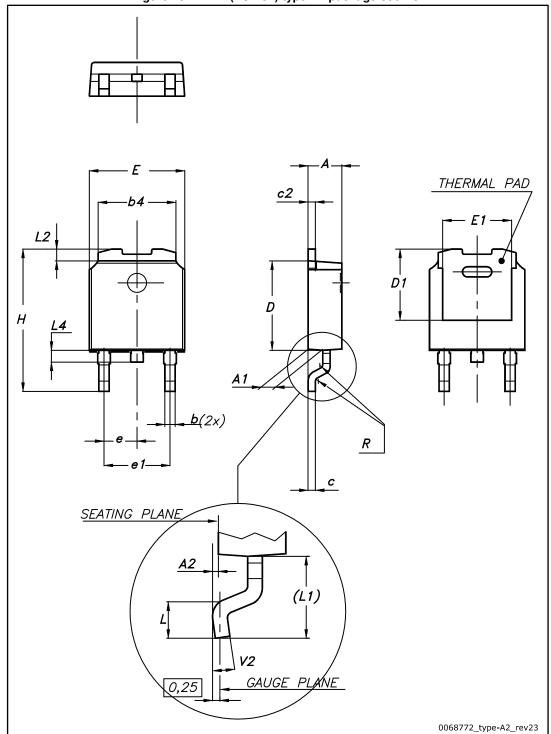
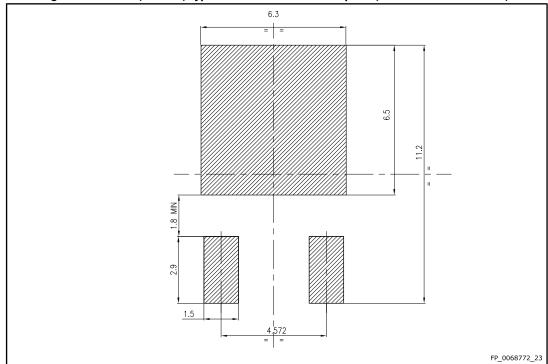


Table 8: DPAK (TO-252) type A2 mechanical data

		mm	
Dim.	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
Е	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

Figure 20: DPAK (TO-252) type A2 recommended footprint (dimensions are in mm)



4.2 DPAK (TO-252) tape and reel mechanical data

Figure 21: DPAK (TO-252) tape outline

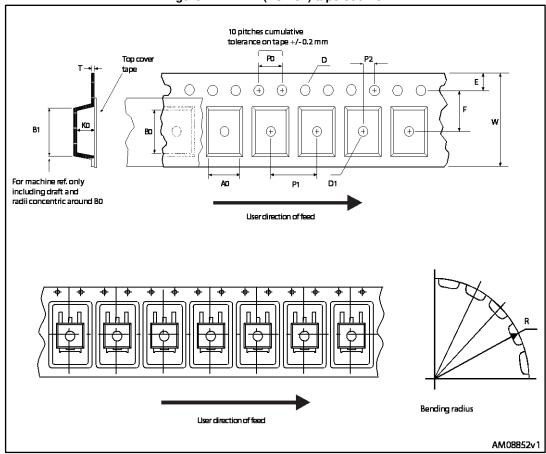




Figure 22: DPAK (TO-252) reel outline

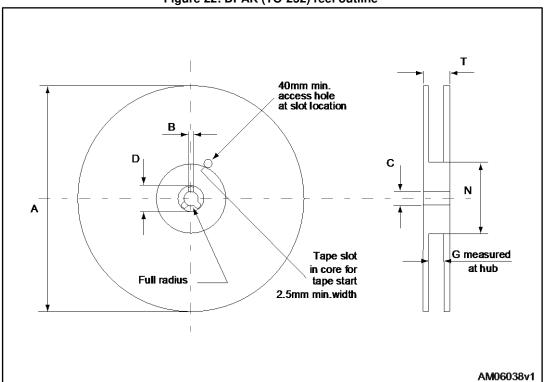


Table 9: DPAK (TO-252) tape and reel mechanical data

	Tape	- / · · · · · · · · · · · · · · · · · ·		Reel	
Dim	m	nm	Dim.	r	nm
Dim.	Min.	Max.	Diiii.	Min.	Max.
A0	6.8	7	А		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	e qty.	2500
P1	7.9	8.1	Bull	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

STD80N6F6 Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
08-Aug-2012	1	Initial release.
17-Jan-2014	2	 Document status promoted from preliminary to production data Modified: title Modified: Features Added: note 1 in cover page Modified: RDS(on)max and ID values in cover page Modified: Derating factor value in Table 2 Modified: RDS(on) values in Table 4 Modified: ID and the entire typical values in Table 5, 6 and 7 Added: Section 2.1: Electrical characteristics (curves) Updated: Section 3: Package mechanical data Minor text changes
23-May-2017	3	Modified title and features on cover page. Modified Table 3: "Thermal data". Modified Section 4: "Package mechanical data". Minor text changes.

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